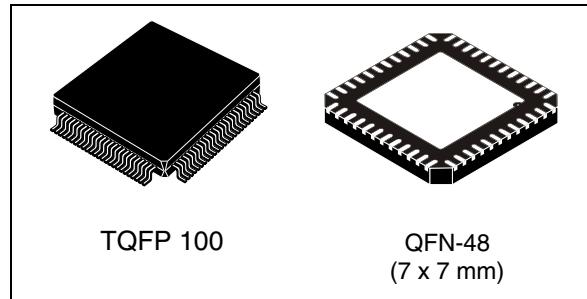


## Narrow-band OFDM power line networking PRIME compliant system-on-chip

### Features

- Fully integrated narrow-band power line networking system-on-chip
- High performing DSP engine with embedded turn-key firmware for Orthogonal frequency division multiplexing (OFDM) modulation, featuring:
  - 96 sub-carriers in CENELEC A band
  - BDPSK, QDPSK, 8DPSK programmable modulations
  - Programmable bit rate up to 128 kbps
  - Convolutional coding and Viterbi decoding
  - Signal to noise ratio and channel quality estimation
  - Full PRIME compliant PHY
- On chip peripherals:
  - Host controller UART/SPI interface
  - I2C/SPI external data memory interface
  - High speed SRAM controller for optional external SRAM program code execution
  - Watchdog timer
- On chip 128 bit AES encryption HW block
- Fully integrated analog front end:
  - ADC and DAC
  - High sensitivity receiver
  - High linearity transmitter with intelligent gain control
- Fully integrated power line driver
  - Up to 1 Arms, 14 Vpp single ended
  - Configurable active filtering topology
  - Ultra low distortion
  - Embedded temperature sensor
  - Current control
- 3.3 V or 5 V I/O digital I/O supply
- Integrated 5 V and 1.8 V linear regulators for AFE and digital core supply
- 8 V to 18 V line driver power supply



- Suitable for applications compliant with EN50065 and FCC part 15 specifications
- -40 °C to +85 °C temperature range
- QFN48 7x7 (ST7590) and TQFP 100 14x14 (ST7590T) exposed pad package options

### Application

PRIME compliant smart metering and smart grid applications.

### Description

ST7590 is the first complete Narrowband OFDM power line communication system-on-chip made using a multi-power technology with state of the art VLSI CMOS lithography. The ST7590 is based on dual core architecture to assure outstanding communication performance with a very high level of flexibility and programmability for either open standard or fully customized implementations.

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# 1 Device description

ST7590 is available in two different package options: TQFP100 and QFN48.

In the TQFP100 package option, order code ST7590T, the device comes with a dedicated FW implementing PRIME compliant PHY protocol Layer and a boot loader procedure that enables the IC to boot PRIME MAC, PRIME CL432 Convergence Layer and IEC 61334-4-32 LLC Layer from an external Serial NV memory connected through SPI interface.

In the QFN 48 package option, ST7590 comes with a dedicated FW implementing the full PRIME protocol stack (PHY, MAC and Convergence Layer), so without the need for external memories to run the protocol.

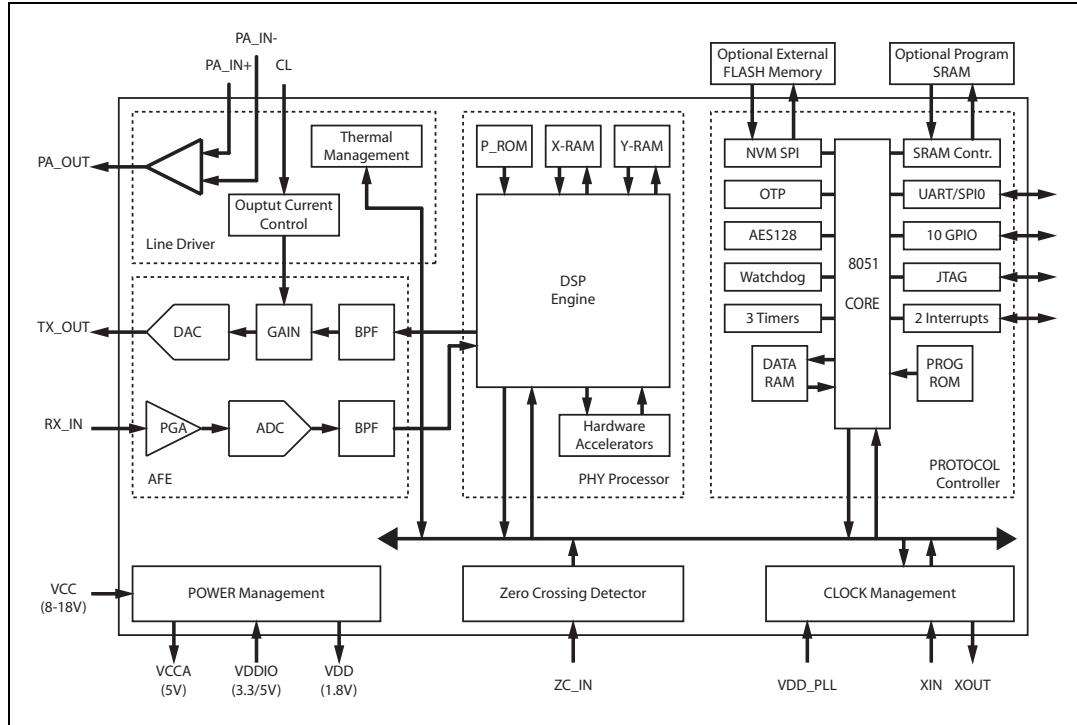
The on-chip analog front end, featuring analog to digital and digital to analog conversion and automatic gain control, plus the integrated power amplifier delivering up to 1 Arms (typical) output current, makes the ST7590 the first complete Narrowband OFDM power line communication system-on-chip ideal for PRIME compliant applications.

An HW 128-bit AES encryption block with PRIME compliant management is available on chip when secure communication is requested.

Line coupling network design is also extremely simplified, leading to a very low cost Bill Of Material.

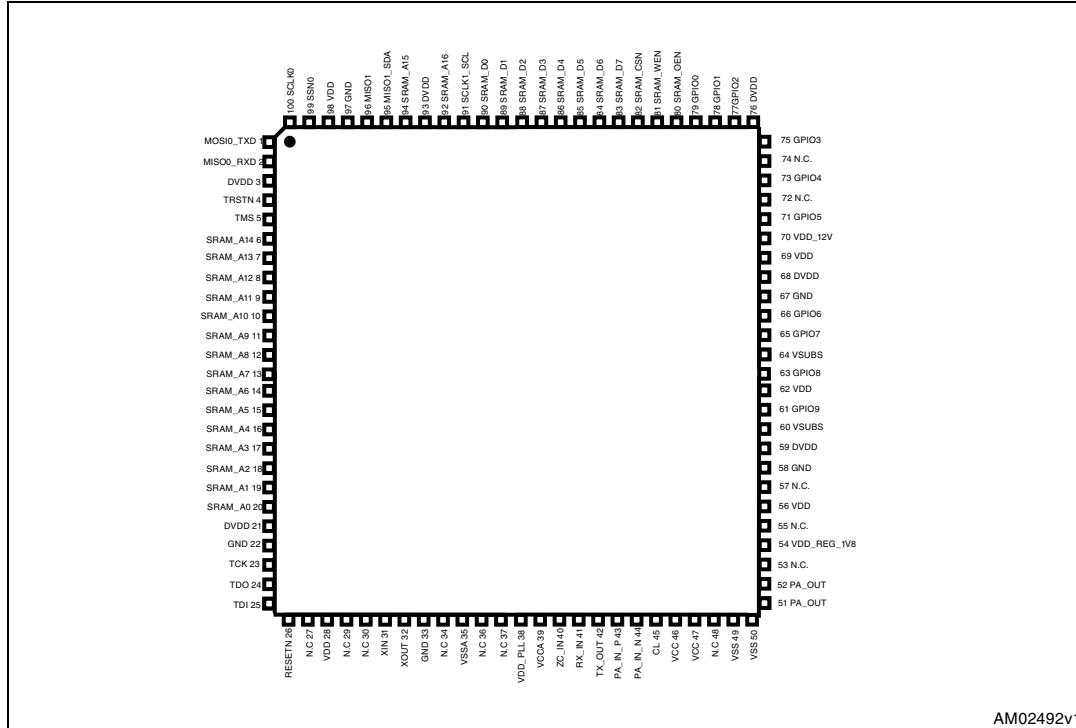
Safe operations are assured while keeping power consumption and distortion levels very low, so making ST7590 an ideal platform for the most stringent application requirements and regulatory standards compliance.

**Figure 1. ST7590 block diagram**



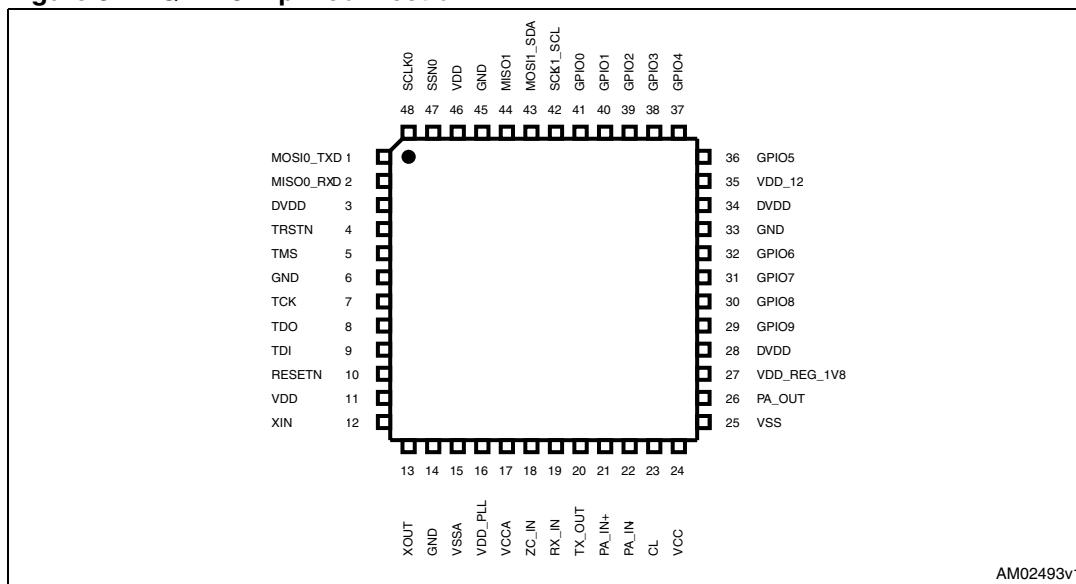
## 2 Pin connection

**Figure 2.** TQFP100 pin connection



AM02492v1

**Figure 3.** QFN48<sup>(a)</sup> pin connection



AM02493v1

- a. The QFN48 package option does not allow the connection with an external memory; in this configuration the ST7590 will run the code present in the embedded ROM only.

**Table 1. Pin description**

| Name      | Pin  |     | Type                       | Description   |
|-----------|------|-----|----------------------------|---|
|           | TQFP | QFN |                            |   |
| SCLK0     | 100  | 48  | Digital input              | SPI0 serial clock   |
| SSN0      | 99   | 47  | Digital input              | SPII0 slave select (active low)                                     |
| VDD       | 98   | 46  | Power                      | Digital power supply (1.8 V)  |
| GND       | 97   | 45  | Power                      | Ground  |
| MISO1     | 96   | 44  | Digital input              | SPI1 data in  |
| MOSI1_SDA | 95   | 43  | Digital I/O                | SPI1 data out, I2C data in (I2C always selected at boot)            |
| SRAM_A15  | 94   | -   | Digital output             | External SRAM Address   |
| VDDIO     | 93   | -   | Power                      | 3.3 V - 5 V I/O supply  |
| SRAM_A16  | 92   | -   | Digital output             | External SRAM Address   |
| SCLK1_SCL | 91   | 42  | Digital output             | SPI1 serial clock, I2C serial clock ((I2C always selected at boot)) |
| SRAM_D0   | 90   | -   | Digital I/O <sup>(1)</sup> | External SRAM data I/O  |
| SRAM_D1   | 89   | -   | Digital I/O <sup>(1)</sup> | External SRAM data I/O  |
| SRAM_D2   | 88   | -   | Digital I/O <sup>(1)</sup> | External SRAM data I/O  |
| SRAM_D3   | 87   | -   | Digital I/O <sup>(1)</sup> | External SRAM data I/O  |
| SRAM_D4   | 86   | -   | Digital I/O <sup>(1)</sup> | External SRAM data I/O  |
| SRAM_D5   | 85   | -   | Digital I/O <sup>(1)</sup> | External SRAM data I/O  |
| SRAM_D6   | 84   | -   | Digital I/O <sup>(1)</sup> | External SRAM data I/O  |
| SRAM_D7   | 83   | -   | Digital I/O <sup>(1)</sup> | External SRAM data I/O  |
| SRAM_CSN  | 82   | -   | Digital output             | External SRAM chip select   |
| SRAM_WEN  | 81   | -   | Digital output             | External SRAM write enable  |
| SRAM_OEN  | 80   | -   | Digital output             | External SRAM output enable   |
| GPIO0     | 79   | 41  | Digital I/O                | General purpose I/O   |
| GPIO1     | 78   | 40  | Digital I/O                | General purpose I/O   |
| GPIO2     | 77   | 39  | Digital I/O                | General purpose I/O   |
| VDDIO     | 76   | -   | Power                      | 3.3 V - 5 V I/O supply  |
| GPIO3     | 75   | 38  | Digital I/O                | General purpose I/O   |
| N.C       | 74   | -   |                            | Not connected   |
| GPIO4     | 73   | 37  | Digital I/O                | General purpose I/O   |
| N.C       | 72   | -   |                            | Not connected   |
| GPIO5     | 71   | 36  | Digital I/O                | General purpose I/O   |
| VDD_12V   | 70   | 35  | Power                      | OTP programming voltage (12 V)                                      |
| VDD       | 69   | -   | Power                      | Digital power supply (1.8 V)  |
| VDDIO     | 68   | 34  | Power                      | 3.3 V - 5 V I/O supply  |
| GND       | 67   | 33  | Power                      | Ground  |

**Table 1. Pin description (continued)**

| Name        | Pin  |     | Type          | Description   |
|-------------|------|-----|---------------|---|
|             | TQFP | QFN |               |   |
| GPIO6       | 66   | 32  | Digital I/O   | General purpose I/O                                   |
| GPIO7       | 65   | 31  | Digital I/O   | General purpose I/O                                   |
| VSUBS       | 64   | -   | Power         | Analog ground   |
| GPIO8       | 63   | 30  | Digital I/O   | General purpose I/O                                   |
| VDD         | 62   | -   | Power         | Digital power supply (1.8 V)                          |
| GPIO9       | 61   | 29  | Digital I/O   | General purpose I/O                                   |
| VSUBS       | 60   | -   | Power         | Substrate ground                                      |
| VDDIO       | 59   | 28  | Power         | 3.3 V - 5 V I/O supply                                |
| GND         | 58   | -   | Power         | Ground  |
| N.C         | 57   | -   |               | Not connected   |
| VDD         | 56   | -   | Power         | Digital power supply (1.8 V)                          |
| N.C         | 55   | -   |               | Not connected   |
| VDD_REG_1V8 | 54   | 27  | Power         | 1.8 V digital power supply, internal regulator output |
| N.C         | 53   | -   |               | Not connected   |
| PA_OUT      | 52   | 26  | Analog output | Power amplifier output                                |
| PA_OUT      | 51   | -   | Analog output | Power amplifier output                                |
| VSS         | 50   | 25  | Power         | Power ground  |
| VSS         | 49   | -   | Power         | Power ground  |
| N.C         | 48   | -   |               | Not connected   |
| VCC         | 47   | 24  | Power         | 12 V to 20 V power supply                             |
| VCC         | 46   | -   | Power         | 12 V to 20 V power supply                             |
| CL          | 45   | 23  | Analog Input  | Current limiting feedback                             |
| PA_IN_N     | 44   | 22  | Analog Input  | Power amplifier inverting input                       |
| PA_IN_P     | 43   | 21  | Analog Input  | Power amplifier non-inverting input                   |
| TX_OUT      | 42   | 20  | Analog Output | Transmission analog output                            |
| RX_IN       | 41   | 19  | Analog Input  | Reception analog input                                |
| ZC_IN       | 40   | 18  | Analog Input  | Zero crossing detection input                         |
| VCCA        | 39   | 17  | Power         | 5 V analog supply, internal regulator output          |
| VDD_PLL     | 38   | 16  | Power         | 1.8 V PLL supply voltage                              |
| N.C         | 37   | -   |               | Not connected   |
| N.C         | 36   | -   |               | Not connected   |
| VSSA        | 35   | 15  | Power         | Analog ground   |
| N.C         | 34   | -   |               | Not connected   |
| GND         | 33   | 14  | Power         | Ground  |

**Table 1. Pin description (continued)**

| Name      | Pin  |     | Type                         | Description                                       |
|-----------|------|-----|------------------------------|---|
|           | TQFP | QFN |                              |   |
| XOUT      | 32   | 13  | Analog                       | Crystal oscillator output                         |
| XIN       | 31   | 12  | Analog                       | Crystal oscillator input                          |
| N.C       | 30   | -   |                              | Not connected                                     |
| N.C       | 29   | -   |                              | Not connected                                     |
| VDD       | 28   | 11  | Power                        | Digital power supply (1.8 V)                      |
| N.C       | 27   | -   |                              | Not connected                                     |
| RESETN    | 26   | 10  | Digital input                | System reset (active low)                         |
| TDI       | 25   | 9   | Digital input <sup>(1)</sup> | System/M851EW JTAG interface data in              |
| TDO       | 24   | 8   | Digital I/O                  | System/M851EW JTAG interface data out             |
| TCK       | 23   | 7   | Digital input                | System/M851EW JTAG interface clock                |
| GND       | 22   | 6   | Power                        | Ground  |
| VDDIO     | 21   | -   | Power                        | 3.3 V - 5 V I/O supply                            |
| SRAM_A0   | 20   | -   | Digital output               | External SRAM address                             |
| SRAM_A1   | 19   | -   | Digital output               | External SRAM address                             |
| SRAM_A2   | 18   | -   | Digital output               | External SRAM address                             |
| SRAM_A3   | 17   | -   | Digital output               | External SRAM address                             |
| SRAM_A4   | 16   | -   | Digital output               | External SRAM address                             |
| SRAM_A5   | 15   | -   | Digital output               | External SRAM address                             |
| SRAM_A6   | 14   | -   | Digital output               | External SRAM address                             |
| SRAM_A7   | 13   | -   | Digital output               | External SRAM address                             |
| SRAM_A8   | 12   | -   | Digital output               | External SRAM address                             |
| SRAM_A9   | 11   | -   | Digital output               | External SRAM address                             |
| SRAM_A10  | 10   | -   | Digital output               | External SRAM address                             |
| SRAM_A11  | 9    | -   | Digital output               | External SRAM address                             |
| SRAM_A12  | 8    | -   | Digital output               | External SRAM address                             |
| SRAM_A13  | 7    | -   | Digital output               | External SRAM address                             |
| SRAM_A14  | 6    | -   | Digital output               | External SRAM address                             |
| TMS       | 5    | 5   | Digital input <sup>(1)</sup> | System/M8051EW JTAG interface test mode selection |
| TRSTN     | 4    | 4   | Digital input <sup>(1)</sup> | System/M8051EW JTAG interface reset (active low)  |
| VDDIO     | 3    | 3   | Power                        | 3.3 V - 5 V I/O supply                            |
| MISO0_RXD | 2    | 2   | Digital I/O                  | UART data in, SPI0 data out                       |
| MOSI0_TXD | 1    | 1   | Digital I/O                  | UART data out, SPI0 data in                       |

1. Active Pull up (only in input mode for bi-directional pins)

## 3 Maximum ratings

### 3.1 Absolute maximum ratings

**Table 2. Absolute maximum ratings**

| Symbol           | Parameter   | Value       |           | Unit  |
|------------------|---|-------------|-----------|-------|
|                  |   | Min         | Max       |       |
| VCC              | Power supply voltage  | -0.3        | 20        | V     |
| VSSA-GND         | Voltage between VSSA and GND  | -0.3        | 0.3       | V     |
| VDDIO            | I/O supply voltage  | -0.3        | 5.5       | V     |
| VI               | Digital input voltage   | GND-0.3     | VDDIO+0.3 | V     |
| VO               | Digital output voltage  | GND-0.3     | VDDIO+0.3 | V     |
| V(PA_IN)         | PA inputs voltage range   | VSS-0.3     | VCC+0.3   | V     |
| V(PA_OUT)        | PA_OUT voltage range  | VSS-0.3     | VCC+0.3   | V     |
| V(RX_IN)         | RX_IN voltage range   | -(VCCA+0.3) | VCC+0.3   | V     |
| V(ZC_IN)         | ZC_IN voltage range   | -(VCCA+0.3) | VCCA+0.3  | V     |
| V(TX_OUT, CL)    | TX_OUT, CL voltage range  | VSSA-0.3    | VCCA+0.3  | V     |
| V(XIN)           | XIN voltage range   | GND-0.3     | VDDIO+0.3 | V     |
| I(PA_OUT)        | Power amplifier output non-repetitive peak current  |             | 5         | Apeak |
| I(PA_OUT)        | Power amplifier output non-repetitive rms current   |             | 1.4       | Arms  |
| T <sub>amb</sub> | Operating ambient temperature   | -40         | 85        | °C    |
| T <sub>stg</sub> | Storage temperature   | -50         | 150       | °C    |
| V(ESD)           | Maximum withstanding voltage range<br>test condition: cdf-aec-q100-002 "human body model" acceptance criteria: "normal performance" | -2          | +2        | kV    |

### 3.2 Thermal data

**Table 3. Thermal characteristics <sup>(1)</sup>**

| Symbol             | Parameter   | QFN48 | TQFP100 | Unit |
|--------------------|---|-------|---------|------|
| R <sub>thJA1</sub> | Maximum thermal resistance junction-ambient steady state <sup>(2)</sup> | 58    | 50      | °C/W |
| R <sub>thJA2</sub> | Maximum thermal resistance junction-ambient steady state <sup>(3)</sup> | 32    | 25      | °C/W |

1. Typical values.
2. Mounted on a 2s PCB.
3. Mounted on a 2s2p PCB, with a dissipating surface, connected through vias, on the bottom side of the PCB.

### 3.3 Electrical characteristics

$T_A = -40$  to  $+85$  °C,  $T_J < 125$  °C,  $V_{CC} = 18$  V unless otherwise specified.

Table 4. Electrical characteristics

| Symbol                 | Parameter  | Test conditions                    | Min.               | Typ.     | Max. | Unit |
|------------------------|--|------------------------------------|--------------------|----------|------|------|
| <b>Power supply</b>    |  |                                    |                    |          |      |      |
| $V_{CC}$               | Power supply voltage                                     |                                    | 8                  | 13       | 18   | V    |
| $I_{(VCC) RX}$         | Power supply current - Rx mode                           | VCCA externally supplied           |                    | 0.35     | 0.5  | mA   |
| $I_{(VCC) TX}$         | Power supply current - Tx mode, no load                  |                                    |                    | 22       | 30   | mA   |
| $V_{CC\ UVLO\_TL}$     | $V_{CC}$ under voltage lock out low threshold            |                                    | 6.1                | 6.5      | 6.95 | V    |
| $V_{CC\ UVLO\_TH}$     | $V_{CC}$ under voltage lock out high threshold           |                                    | 6.8                | 7.2      | 7.5  | V    |
| $V_{CC\ UVLO\_HYST}$   | $V_{CC}$ under voltage lock out hysteresis               |                                    | 250 <sup>(1)</sup> | 700      |      | mV   |
| $V_{CCA}$              | Analog supply voltage                                    | Externally supplied                | -5%                | 5        | +5%  | V    |
| $I_{(VCCA) RX}$        | Analog supply current - Rx mode                          |                                    |                    | 5        | 6    | mA   |
| $I_{(VCCA) TX}$        | Analog supply current - Tx mode                          | $V_{(TX\_OUT)} = 5$ V p-p, No load |                    | 8        | 10   | mA   |
| $V_{DD}$               | Digital core supply voltage                              | Externally supplied                | -10%               | 1.8      | +10% | V    |
| $I_{(VDD)}$            | Digital core supply current                              |                                    |                    | 35       |      | mA   |
| $I_{(VDD)}$            | Digital core supply current in RESET state               |                                    |                    | 8        |      | mA   |
| $V_{DD\_PLL}$          | PLL supply voltage                                       |                                    |                    | VDD      |      | V    |
| $I_{(VDD\_PLL)}$       | PLL supply current                                       |                                    |                    | 0.4      |      | mA   |
| $V_{DDIO}$             | Digital I/O supply voltage                               | Externally supplied                | -10%               | 3.3 or 5 | +10% | V    |
| $V_{DDIO\ UVLO\_TL}$   | I/O supply voltage under voltage lock out low threshold  |                                    | 2.25               | 2.4      | 2.6  | V    |
| $V_{DDIO\ UVLO\_TH}$   | I/O supply voltage under voltage lock out high threshold |                                    | 2.45               | 2.6      | 2.8  | V    |
| $V_{DDIO\ UVLO\_HYST}$ | I/O supply voltage under voltage lock out hysteresis     |                                    |                    | 250      |      | mV   |



**Table 4. Electrical characteristics (continued)**

| Symbol                  | Parameter  | Test conditions  | Min.  | Typ.   | Max.   | Unit  |
|-------------------------|--|--|-------|--------|--------|-------|
| <b>Analog front end</b> |  |  |       |        |        |       |
| <b>Power amplifier</b>  |  |  |       |        |        |       |
| $V_{(PA\_OUT)BIAS}$     | Power amplifier output bias voltage - Rx mode          |  |       | VCC/2  |        | V     |
| GBWP                    | Power amplifier gain-bandwidth product                 |  | 100   |        |        | MHz   |
| $I_{(PA\_OUT)MAX}$      | Power amplifier maximum output current                 |  |       | 1000   | mA rms |       |
| $V_{(PA\_OUT)TOL}$      | Power amplifier output tolerance <sup>(2)</sup>        |  | -3%   |        | 3%     |       |
| $V_{(PA\_OUT)HD2}$      | Transmitter output 2 <sup>nd</sup> harmonic distortion | $V_{CC}=13\text{ V}$ , $V_{(PA\_OUT)}=7\text{ V p-p}$ ,<br>$V_{(PA\_OUT)BIAS}=VCC/2$ ,<br>$R_{LOAD}=50\ \Omega$<br>see <a href="#">Figure 4</a>  |       | -71    |        | dBc   |
| $V_{(PA\_OUT)HD3}$      | Transmitter output 3 <sup>rd</sup> harmonic distortion |  |       | -68    |        | dBc   |
| $V_{(PA\_OUT)THD}$      | Transmitter output total harmonic distortion           |  |       | 0.1    |        | %     |
| $V_{(PA\_OUT)HD2}$      | Transmitter output 2 <sup>nd</sup> harmonic distortion | $V_{CC}=18\text{ V}$ , $V_{(PA\_OUT)}=14\text{ V p-p}$ ,<br>$V_{(PA\_OUT)BIAS}=VCC/2$ ,<br>$R_{LOAD}=50\ \Omega$<br>see <a href="#">Figure 4</a> |       | -70    |        | dBc   |
| $V_{(PA\_OUT)HD3}$      | Transmitter output 3 <sup>rd</sup> harmonic distortion |  |       | -60    |        | dBc   |
| $V_{(PA\_OUT)THD}$      | Transmitter output total harmonic distortion           |  |       | 0.2    |        | %     |
| $C_{(PA\_IN)}$          | Power amplifier input capacitance                      | $PA\_IN+$ vs. $V_{SS}^{(2)}$   |       | 10     |        | pF    |
|                         |  | $PA\_IN-$ vs. $V_{SS}^{(2)}$   |       | 10     |        | pF    |
| PSRR                    | Power supply rejection ratio                           | dc to 3 kHz  |       | 100    |        | dB    |
|                         |  | 1 kHz  |       | 93     |        | dB    |
|                         |  | 100 kHz  |       | 70     |        | dB    |
| $C_{L\_TH}$             | Current sense high threshold on CL pin                 |  |       | 2.35   |        | V     |
| $C_{L\_RATIO}$          | Ratio between PA_OUT and CL output current             |  |       | 80     |        |       |
| <b>Transmitter</b>      |  |  |       |        |        |       |
| $V_{(TX\_OUT)BIAS}$     | Transmitter output bias voltage - Rx mode              |  |       | VCCA/2 |        | V     |
| $V_{(TX\_OUT)MAX}$      | Transmitter output maximum voltage swing               | Maximum output level, no load<br>$V_{CCA}=5\text{ V}$  | 4.8   | 4.95   | VCCA   | V p-p |
| TXGAIN                  | Transmitter output digital gain range                  |  | -21   | 0      | 0      | dB    |
| TX_GAIN TOL             | Transmitter output digital gain tolerance              |  | -0.35 | 0.35   | 0.35   | dB    |

**Table 4. Electrical characteristics (continued)**

| Symbol                          | Parameter  | Test conditions  | Min. | Typ. | Max.  | Unit  |
|---------------------------------|--|--|------|------|-------|-------|
| $R_{(TX\_OUT)}$                 | Transmitter output resistance                          | RX mode  |      | 1    |       | kΩ    |
| $V_{(TX\_OUT) HD2}$             | Transmitter output 2 <sup>nd</sup> harmonic distortion | $V_{(TX\_OUT)} = 4 \text{ Vpp}$ (TXOUT)MAX,<br>No load, $f_C = 82 \text{ kHz}$ |      | -67  |       | dBc   |
| $V_{(TX\_OUT) HD3}$             | Transmitter output 3 <sup>rd</sup> harmonic distortion |  |      | -70  |       | dBc   |
| $V_{(TX\_OUT) THD}$             | Transmitter output total harmonic distortion           |  |      | 0.1  |       | %     |
| <b>Receiver</b>                 |  |  |      |      |       |       |
| $V_{(RX\_IN) MAX}$              | Receiver input maximum voltage                         | $V_{CC} = 18 \text{ V}$  |      | 16   |       | V p-p |
| $V_{(RX\_IN) BIAS}$             | Receiver input bias voltage                            |  |      | 2.5  |       | V     |
| $Z_{(RX\_IN)}$                  | Receiver input impedance                               |  |      | 10   |       | kΩ    |
| PGA_MIN                         | PGA minimum gain                                       |  |      | -18  |       | dB    |
| PGA_MAX                         | PGA maximum gain                                       |  |      | 30   |       | dB    |
| <b>Oscillator</b>               |  |  |      |      |       |       |
| $V_{(XIN)}$                     | Oscillator input voltage swing                         | Clock frequency supplied externally  |      | 1.8  | VDDIO | V p-p |
| $V_{(XIN) TH}$                  | Oscillator input voltage threshold                     |  | 0.8  | 0.9  | 1     | V     |
| $V_{(XIN)} f_{OSC}$             | Crystal oscillator frequency                           |  |      | 8    |       | MHz   |
| F(XIN) TOL                      | External quartz crystal frequency tolerance            |  | -150 |      | 150   | ppm   |
| ESR                             | External quartz crystal ESR value                      |  |      |      | 100   | Ω     |
| $C_L$                           | External quartz crystal load capacitance               |  |      | 16   |       | pF    |
| <b>Temperature sensor</b>       |  |  |      |      |       |       |
| T_TH <sub>1</sub>               | Temperature threshold 1                                | (2)  | 63   | 70   | 77    | °C    |
| T_TH <sub>2</sub>               | Temperature threshold 2                                | (2)  | 90   | 100  | 110   | °C    |
| T_TH <sub>3</sub>               | Temperature threshold 3                                | (2)  | 112  | 125  | 138   | °C    |
| T_TH <sub>4</sub>               | Temperature threshold 4                                | (2)  | 153  | 170  | 187   | °C    |
| <b>Zero crossing comparator</b> |  |  |      |      |       |       |
| $V_{(ZC\_IN) MAX}$              | Zero crossing detection input voltage range            |  |      |      | 10    | V p-p |

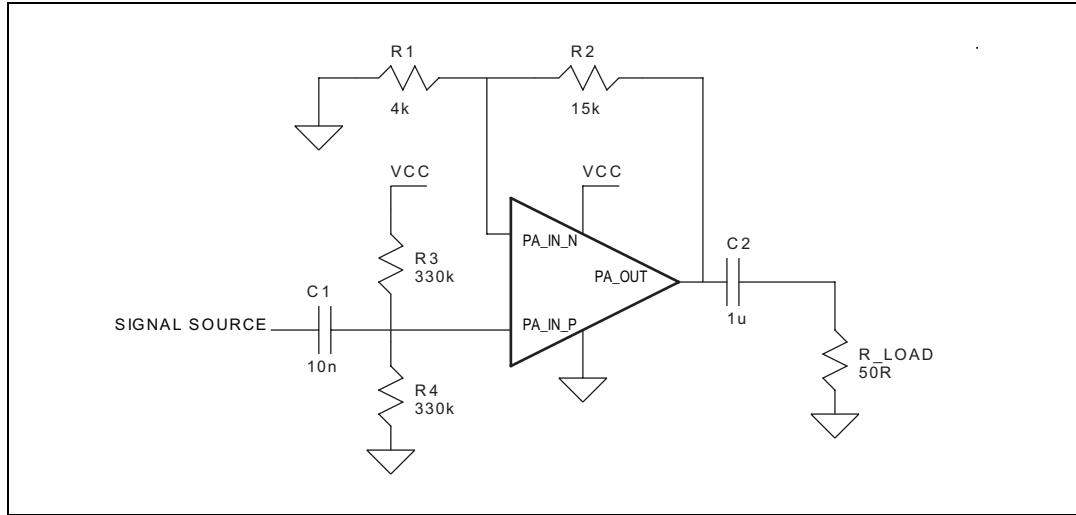
**Table 4. Electrical characteristics (continued)**

| Symbol                    | Parameter  | Test conditions           | Min.             | Typ.  | Max.            | Unit             |
|---------------------------|--|---------------------------|------------------|-------|-----------------|------------------|
| $V_{(ZC\_IN) TL}$         | Zero crossing detection input low threshold      |                           | -44              | -32   | -17             | mV               |
| $V_{(ZC\_IN) TH}$         | Zero crossing detection input high threshold     |                           | 26               | 41    | 56              | mV               |
| $V_{(ZC\_IN) HYST}$       | Zero crossing detection input hysteresis         |                           |                  | 73    |                 | mV               |
| <b>Digital section</b>    |  |                           |                  |       |                 |                  |
| <b>Digital I/O</b>        |  |                           |                  |       |                 |                  |
| $R_{PULL-UP}$             | Internal pull-up resistors                       | $V_{DDIO} = 3.3\text{ V}$ |                  | 66    |                 | $\text{k}\Omega$ |
|                           |  | $V_{DDIO} = 5\text{ V}$   |                  | 41    |                 |                  |
| $V_{IH}$                  | High logic level input voltage                   |                           | 0.65* $V_{DDIO}$ |       | $V_{DDIO}+0.3$  | V                |
| $V_{IL}$                  | Low logic level input voltage                    |                           | -0.3             |       | $0.35*V_{DDIO}$ | V                |
| $V_{OH}$                  | High logic level output Voltage                  | $I_{OH} = -4\text{ mA}$   | $V_{DDIO}-0.4$   |       |                 | V                |
| $V_{OL}$                  | Low logic level output voltage                   | $I_{OL} = 4\text{ mA}$    |                  |       | 0.4             | V                |
| <b>UART interface</b>     |  |                           |                  |       |                 |                  |
| Data bits                 |  |                           |                  | 8     |                 | Bits             |
| Stop bits                 |  |                           |                  | 1     |                 | Bits             |
| Parity bits               |  |                           |                  | 0     |                 | Bits             |
| Baud rate                 |  |                           | -1.5%            | 57600 | +1.5%           | BAUD             |
|                           |  |                           | -1.5%            | 38400 | +1.5%           | BAUD             |
|                           |  |                           | -1.5%            | 19200 | +1.5%           | BAUD             |
|                           |  |                           | -1.5%            | 9600  | +1.5%           | BAUD             |
| <b>Reset and power on</b> |  |                           |                  |       |                 |                  |
| $t_{RESETN}$              | Minimum valid reset pulse duration               |                           |                  | 1     |                 | $\mu\text{s}$    |
| $t_{STARTUP}$             | Start-up time at power on or after a reset event | (3)                       |                  | 35    | 60              | ms               |

1. Referred to  $T_A = -40^\circ\text{C}$ 

2. This parameter does not include the tolerance of external components

3. Referred to IC start up, uploading code from external NVM and its execution from external RAM may require some second.

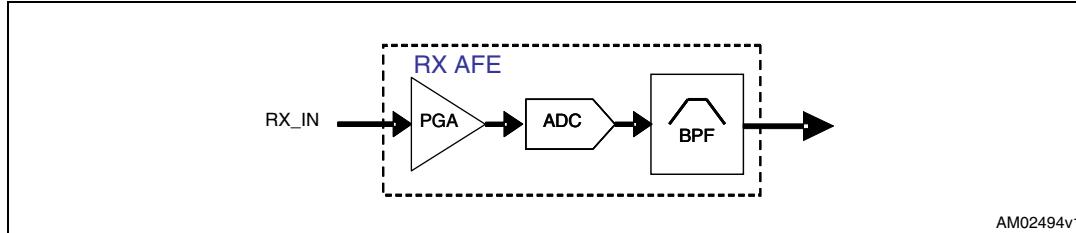
**Figure 4.** Power amplifier test circuit

## 4 Analog front end (AFE)

### 4.1 Reception path

*Figure 5* shows the block diagram of the ST7590 input receiving path. The reception AFE main blocks are a wide input range analog PGA (programmable gain amplifier) and the ADC (analog to digital converter).

**Figure 5. Reception path block diagram**



The PGA is controlled by a loop algorithm that detects the amplifier output signal amplitude and adapts the gain of the amplifier in order to have the optimum input voltage range for the ADC. The PGA gain ranges from -18 dB up to 30 dB (typical), with steps of 6 dB (typical), as described in Table 5.

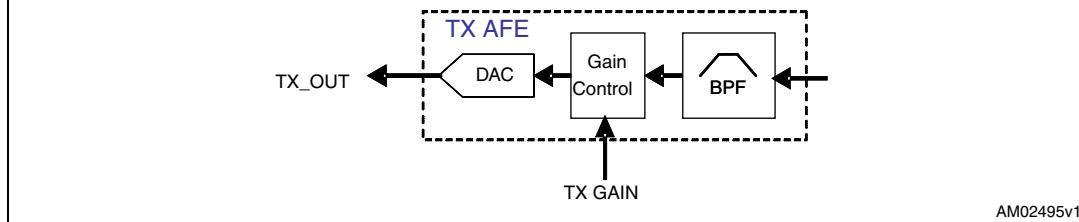
**Table 5. PGA gain table**

| PGA code | PGA gain (typical)<br>[dB] | RX_IN max range<br>[V p-p] |
|----------|----------------------------|----------------------------|
| 0        | -18                        | 16                         |
| 1        | -12                        | 8                          |
| 2        | -6                         | 4                          |
| 3        | 0                          | 2                          |
| 4        | 6                          | 1                          |
| 5        | 12                         | 0.500                      |
| 6        | 18                         | 0.250                      |
| 7        | 24                         | 0.125                      |
| 8        | 30                         | 0.0625                     |

## 4.2 Transmission path

*Figure 6* shows the transmission path block diagram. It is mainly based on a digital to analog converter (DAC), capable to generate a very linear signal up to its full scale output. A gain control block before the DAC gives the possibility to scale down the output signal to match the desired transmission level.

**Figure 6. Transmission path block diagram**



According to PRIME Specifications the output level can be set on a 8-step logarithmic scale between a Maximum Output Level (MOL) and a minimum output level (MOL - 21dB), with steps of 3dB (typical). The maximum level corresponds to the TX\_OUT full range.

## 4.3 Power amplifier

The integrated Power Amplifier is characterized by very high linearity, required to comply with the different international regulations (CENELEC, FCC etc.) limiting the spurious conducted emissions on the mains, and a current capability of 1Arms (typical) that allows the amplifier driving even very low impedance points of the network.

All pins of the Power Amplifier are accessible, making it possible to build an Active Filter network to increase the linearity of the output signal.

## 4.4 Thermal shutdown and temperature control

The ST7590 performs an automatic shutdown of the power amplifier circuitry when the internal temperature exceeds 170 °C. After a Thermal shutdown event, the temperature must get below 125 °C before the ST7590 power amplifier comes back to operation.

Moreover a digital thermometer is embedded to identify the internal temperature among four zones, as indicated in *Table 6*.

**Table 6. Temperature zones**

| Temperature zone | Temperature range (Typ.) |
|------------------|--------------------------|
| 1                | $T < T_{TH1}$            |
| 2                | $T_{TH1} < T < T_{TH2}$  |
| 3                | $T_{TH2} < T < T_{TH3}$  |
| 4                | $T > T_{TH3}$            |

## 4.5 Zero-crossing detector

The ST7590 embeds an analog comparator with hysteresis, used for zero-crossing detection. Information about zero crossing events is managed as specified in PRIME protocol specifications.

## 4.6 One time programmable (OTP) memory array

ST7590 comes with an embedded 64 bit OTP array. This OTP memory is used to store hardware trimming values and the unique identifier EUI48, used for unique addressing in PRIME MAC protocol.

OTP array is composed of 4 16 bit words, indexed from 0 to 3, where the first (index 0) contains hardware trimming values, while the others contain the EUI48 address as specified in [Table 7](#).

**Table 7. OTP memory array**

| Index | LSB                          | MSB           |
|-------|------------------------------|---------------|
| 0     | Reserved – hardware trimming |               |
| 1     | EUI48[0..7]                  | EUI48[8..15]  |
| 2     | EUI48[16..23]                | EUI48[24..31] |
| 3     | EUI48[32..39]                | EUI48[40..47] |

## 4.7 Power management

[Figure 7](#) shows the power supply structure for the ST7590. The ST7590 operates from two external supply voltages:

- VCC (8 to 18 V) as the main power supply;
- VDDIO (3.3 or 5 V) for the I/O and digital sections.

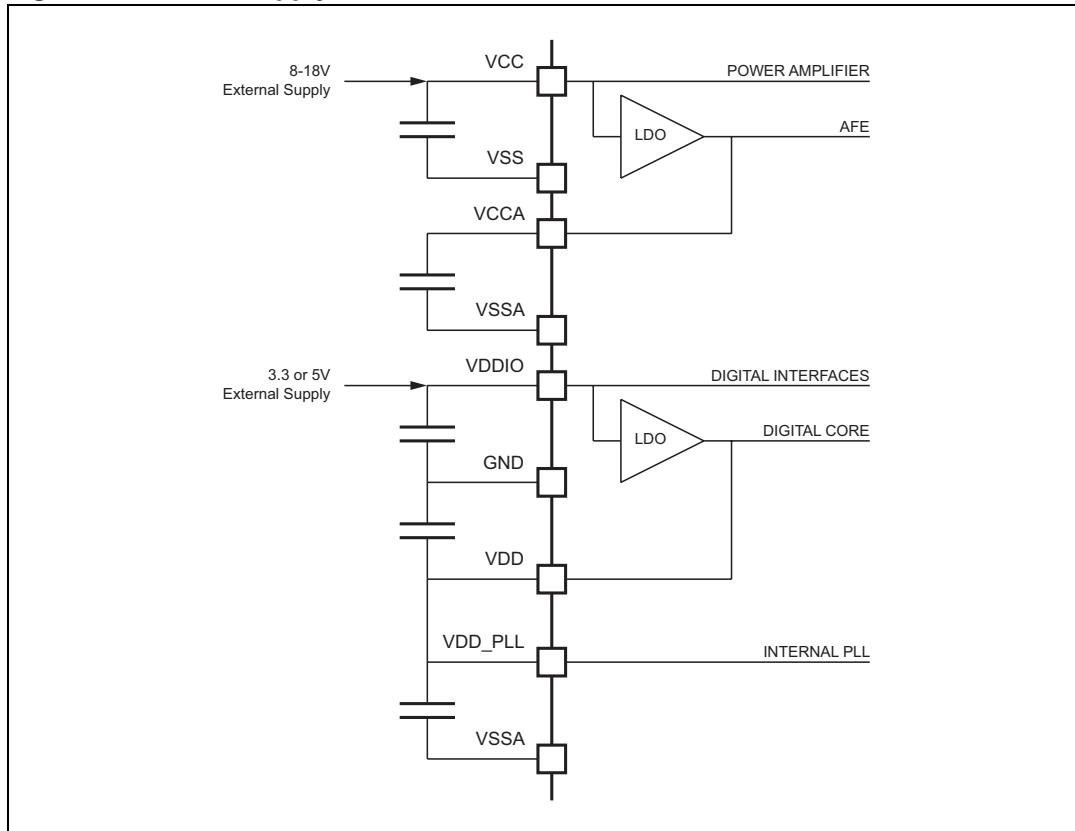
Two internal linear regulators provide the remaining required voltages:

- 5 V regulator (used by the analog front end blocks), generated from the VCC voltage and connected to the VCCA pin;
- 1.8 V regulator (required for the DSP and microcontroller cores, the digital blocks, the PLL and the oscillator), generated from the VDDIO voltage and connected to the VDD\_REG\_1V8 pin.

All the supply voltages must be properly filtered, to their respective ground, using external capacitors close to each supply pin (see [Figure 7](#)).

*Note:*

*The internal regulators connected to VDD\_REG\_1V8 and VCCA are not designed to supply external circuitry; their output is externally accessible for filtering purpose only.*

**Figure 7. Power supply internal scheme**

## 4.8 Clock management

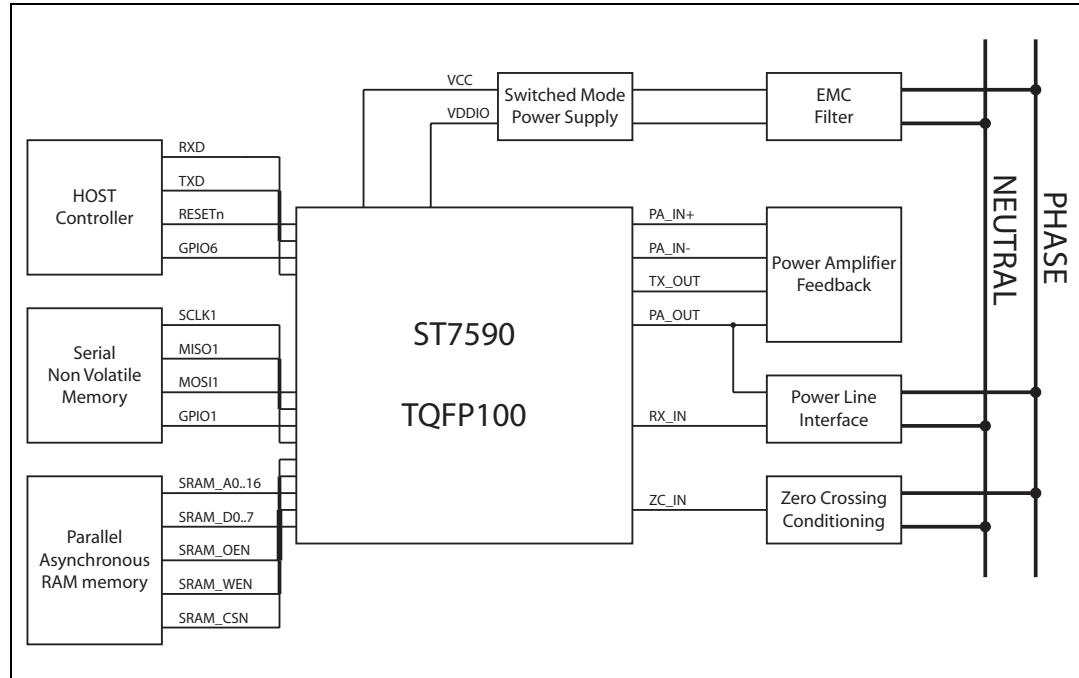
The main clock source is an 8 MHz crystal connected to the internal oscillator through XIN and XOUT pins. Both XIN and XOUT pins have a 32 pF integrated capacitor, in order to drive a crystal having a load capacitance of 16 pF with no additional components.

Alternatively, an 8 MHz external clock can be directly supplied to XIN pin, leaving XOUT floating.

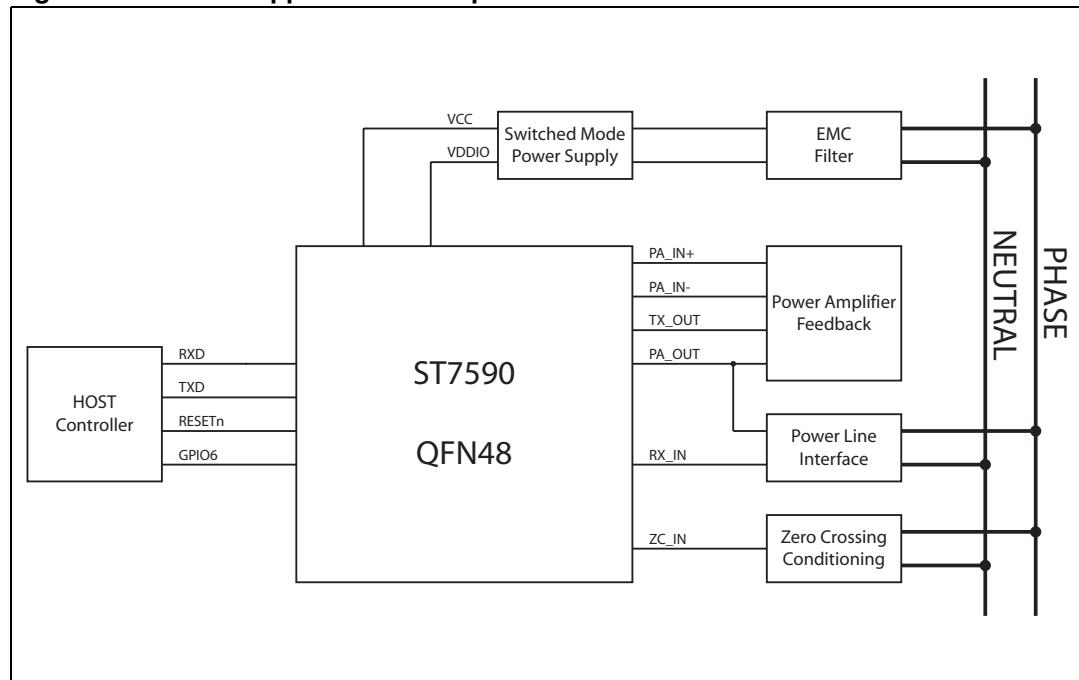
A PLL internally connected to the output of the oscillator generates the internal clocks needed by the digital part.

## 5 Application information

**Figure 8.** TQFP100 128 Kb external memory application example



**Figure 9.** QFN48 application example



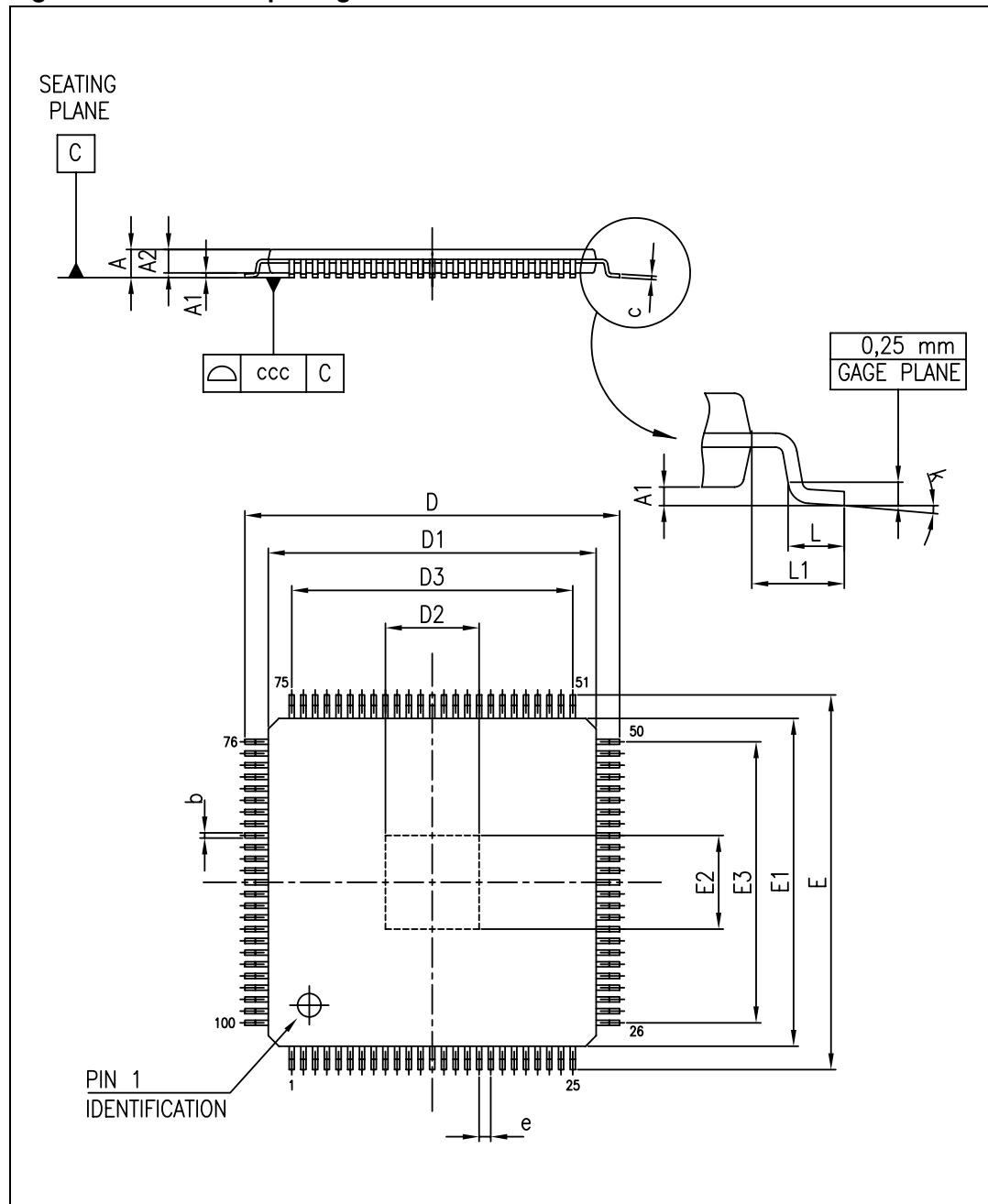
## 6 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com).  
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**Table 8. TQFP 100 package mechanical data**

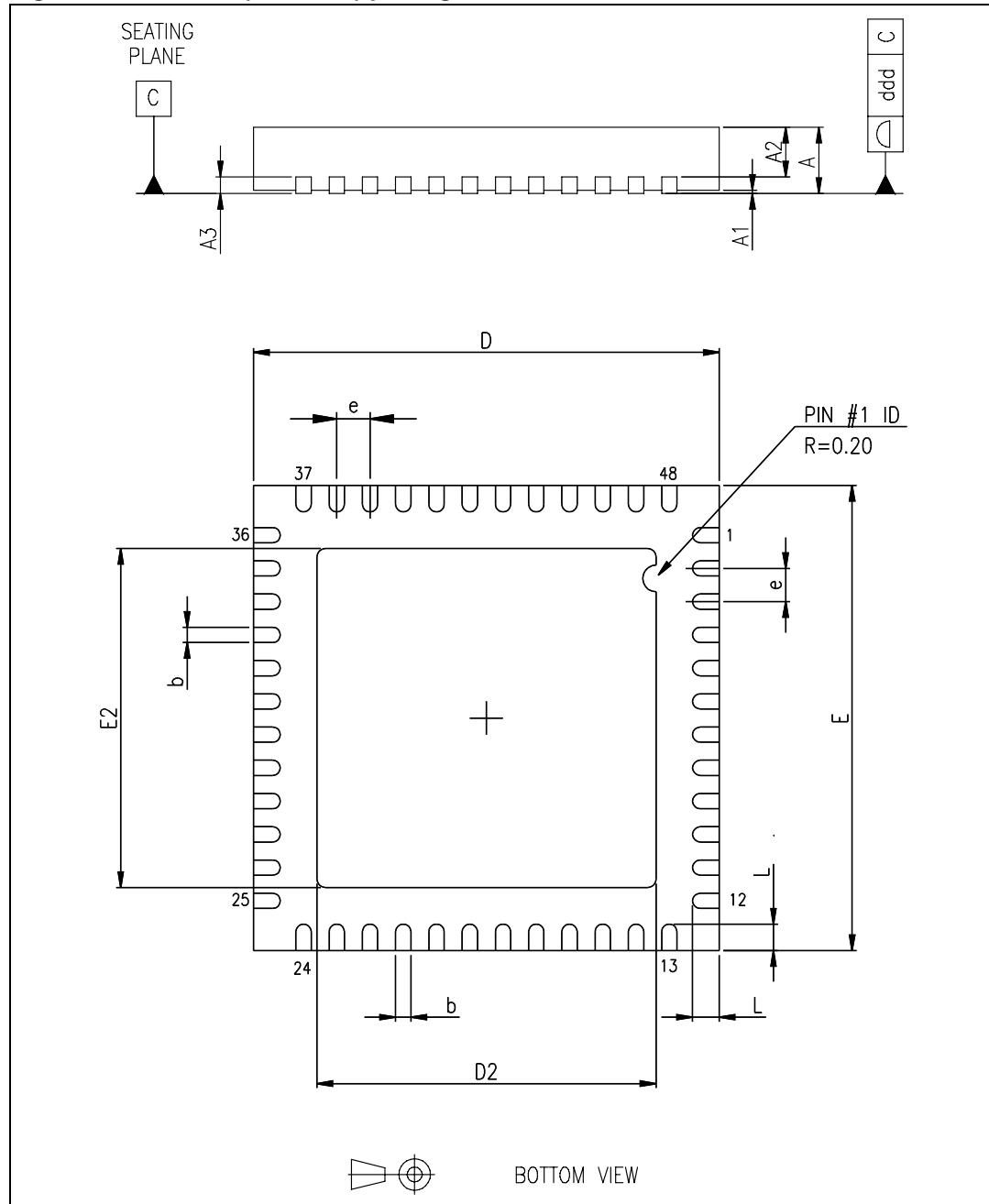
| Dim. | (mm) |      |      |
|------|------|------|------|
|      | Min. | Typ. | Max. |
| A    |      |      | 1.2  |
| A1   | 0.05 |      | 0.15 |
| A2   | 0.95 | 1    | 1.05 |
| b    | 0.17 | 0.22 | 0.27 |
| c    | 0.09 |      | 0.2  |
| D    | 15.8 | 16   | 16.2 |
| D1   | 13.8 | 14   | 14.2 |
| D2   |      | 5.00 | 5.50 |
| D3   |      | 12   |      |
| E    | 15.8 | 16   | 16.2 |
| E1   | 13.8 | 14   | 14.2 |
| E2   |      | 5.00 | 5.50 |
| E3   |      | 12   |      |
| e    |      | 0.5  |      |
| L    | 0.45 | 0.6  | 0.75 |
| L1   |      | 1    |      |
| k    | 0    | 3.5  | 7    |
| ccc  |      |      | 0.08 |

Figure 10. TQFP 100 package outline



**Table 9. QFN-48 (7 x 7 mm) package mechanical data**

| Dim. | (mm) |      |      |
|------|------|------|------|
|      | Min. | Typ. | Max. |
| A    | 0.80 | 0.90 | 1.00 |
| A1   |      | 0.02 | 0.05 |
| A2   |      | 0.65 | 1.00 |
| A3   |      | 0.25 |      |
| b    | 0.18 | 0.23 | 0.30 |
| D    | 6.85 | 7.00 | 7.15 |
| D2   | 4.95 | 5.10 | 5.25 |
| E    | 6.85 | 7.00 | 7.15 |
| E2   | 4.95 | 5.10 | 5.25 |
| e    | 0.45 | 0.50 | 0.55 |
| L    | 0.30 | 0.40 | 0.50 |
| ddd  |      |      | 0.08 |

**Figure 11. QFN-48 (7 x 7 mm) package outline**

## 7 Revision history

**Table 10. Document revision history**

| Date        | Revision | Changes         |
|-------------|----------|-----------------|
| 19-Oct-2011 | 1        | Initial release |

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